

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung  
Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.: 10/720,579 ART UNIT: 1753

FILED: November 24, 2003 EXAMINER: Wong, E.

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS  
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER  
FOIL MANUFACTURED THEREBY

AMENDMENT "C"

Director of the U.S. Patent  
and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Final Action of May 6, 2008, a response being due with a Petition to  
Revoke, please enter the amendments provided herein and consider the following remarks.

The claims are amended.

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CERTIFICATE OF MAILING UNDER 37 CFR 1.8(a)

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

I hereby certify that the attached correspondence comprising:

AMENDMENT "C"

is being deposited with the United States Postal Service with sufficient postage as first class mail  
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P. O. Box 1450  
Alexandria, VA 22313-1450

or by electronic filing on December 2, 2008.

Respectfully submitted,

<u>December 2, 2008</u>	<u>/Andrew W. Chu/</u>
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